SMAJ-E Series

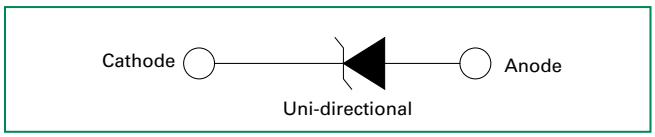
OBSOLETE DATE: 08/21/2020 PCN/ECN# 41356
REPLACED BY: SMAJ Series

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T_A=25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2)	P_{PPM}	400	W
Power Dissipation on Infinite Heat Sink at T_L=50°C	P_D	3.3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I_{FSM}	60	A
Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only	V_F	3.5	V
Operating Temperature Range	T_J	-65 to 150	°C
Storage Temperature Range	T_{STG}	-65 to 175	°C
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	30	°C/W
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	120	°C/W

Notes:
1. Non-repetitive current pulse, per Fig.4 and derated above T_J (initial) =25°C per Fig. 3.
2. Mounted on 5.0x5.0mm copper pad to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only.

Functional Diagram



Description

The SMAJ-E series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- Excellent clamping capability
- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC 61000-4-2 ESD 30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- 400W Peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to V_{BR} min
- Glass passivated junction
- Low inductance
- High temperature to reflow soldering guaranteed: 260°C/40sec
- V_{BR} @ T_J= V_{BR}@25°C x (1+αT x (T_J - 25)) (αT:Temperature Coefficient, typical value is 0.1%)
- EPI silicon technology
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead–free Plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

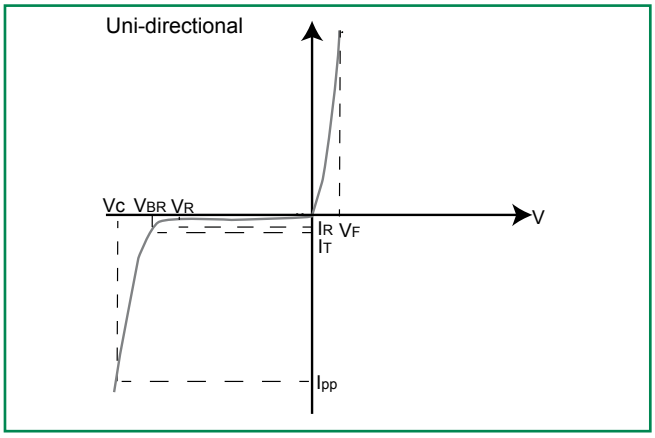
TVS Diodes
Surface Mount – 400W > SMAJ-E Series

Electrical Characteristics (T_A=25°C unless otherwise noted)

Part Number (Uni)	Marking	Reverse Stand off Voltage V_R (Volts)	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T (mA)	Maximum Clamping Voltage V_C @ I_{pp} (V)	Maximum Peak Pulse Current I_{pp} (A)	Maximum Reverse Leakage I_R @ V_R (µA)
			MIN	MAX				
SMAJ300A-E	XE	300	335.0	371.0	1	486.0	0.80	1
SMAJ350A-E	XG	350	391.0	432.0	1	567.0	0.70	1
SMAJ400A-E*	XK	400	447.0	494.0	1	648.0	0.60	1
SMAJ450A-E*	XM	440	492.0	543.0	1	713.0	0.60	1
SMAJ500A-E*	XN	500	558.0	618.0	1	810.0	0.50	1
SMAJ550A-E*	XP	550	614.0	680.0	1	891.0	0.46	1
SMAJ600A-E*	XR	600	670.0	741.0	1	971.0	0.42	1
SMAJ650A-E*	XS	650	726.0	803.0	1	1052.0	0.39	1
SMAJ700A-E*	XT	700	782.0	865.0	1	1133.0	0.36	1
SMAJ750A-E*	XU	750	837.0	927.0	1	1213.0	0.33	1
SMAJ850A-E*	XV	850	950.0	1050.0	1	1365.0	0.30	1

Note: for parts with * are still under development

I-V Curve Characteristics



P_{PPM} Peak Pulse Power Dissipation – Max power dissipation

V_R Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

V_{BR} Breakdown Voltage – Maximum voltage that flows though the TVS at a specified test current (I_T)

V_C Clamping Voltage – Peak voltage measured across the TVS at a specified Ippm (peak impulse current)

I_R Reverse Leakage Current – Current measured at V_R

V_F Forward Voltage Drop for Uni-directional

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Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

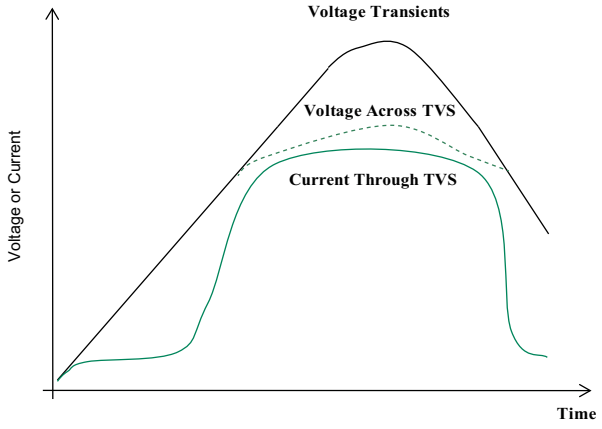

Figure 2 - Peak Pulse Power Rating Curve

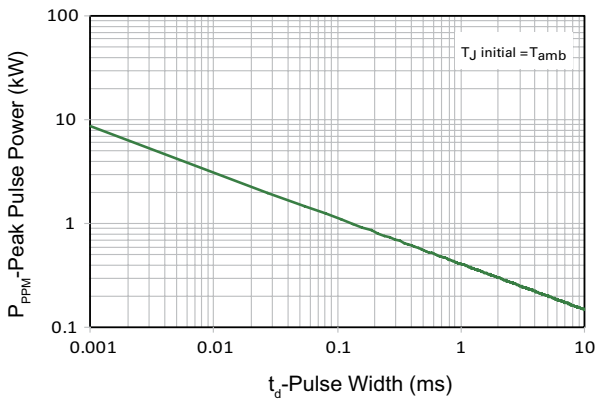

Figure 3 - Peak Pulse Power Derating Curve

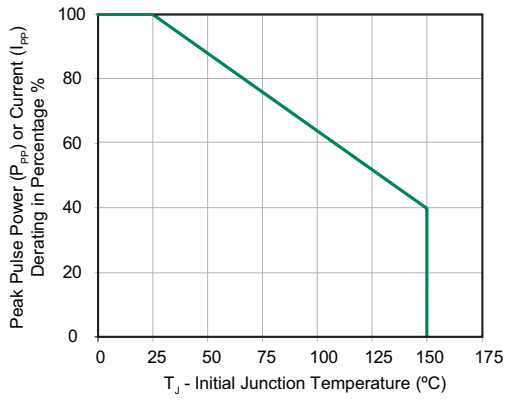

Figure 4 - Pulse Waveform

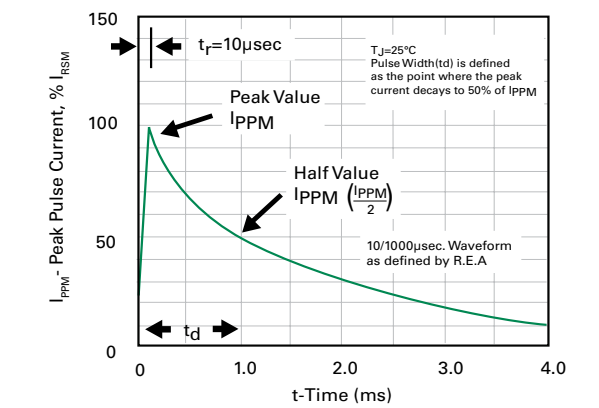

Figure 5 - Typical Junction Capacitance

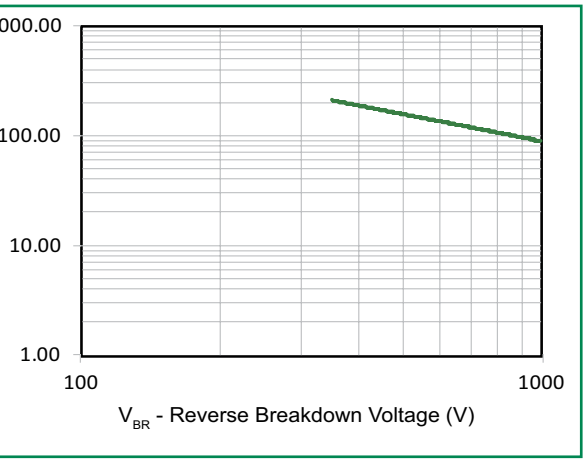

Figure 6 - Typical Transient Thermal Impedance

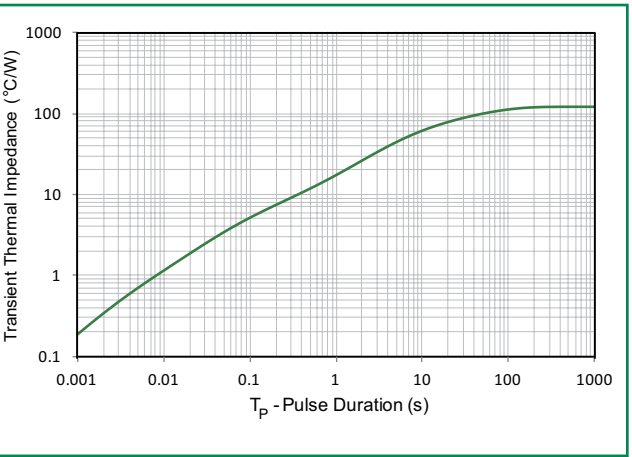

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Figure 7 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

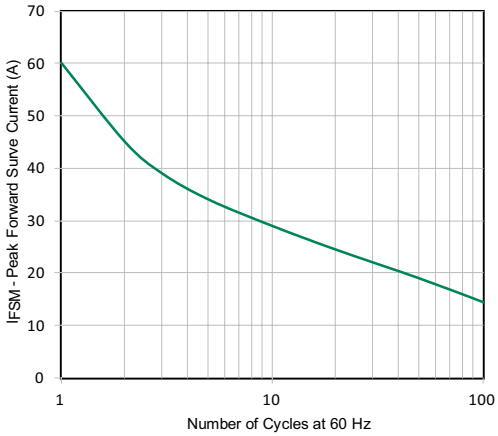
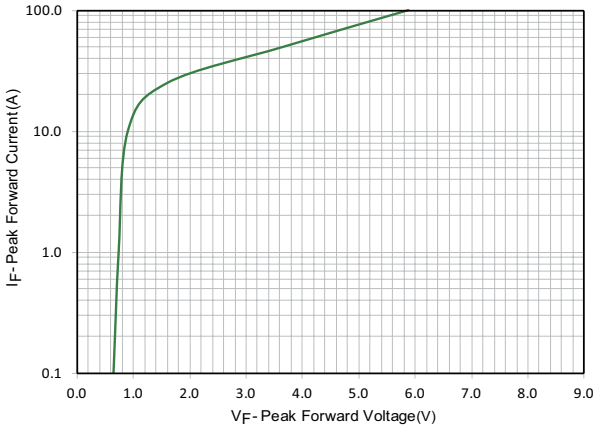
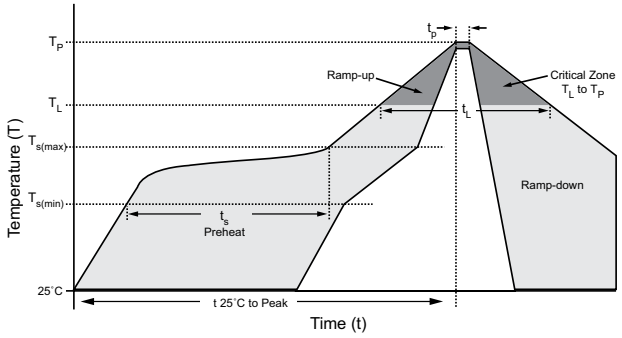


Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



Soldering Parameters

Reflow Condition		Lead–free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_A) to peak		3°C/second max
$T_{S(max)}$ to T_A - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_A) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_P)		$260^{+0/-5}$ °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		260°C



Physical Specifications

Weight	0.002 ounce, 0.061 gram
Case	JEDEC DO-214AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except Bipolar
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102

Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

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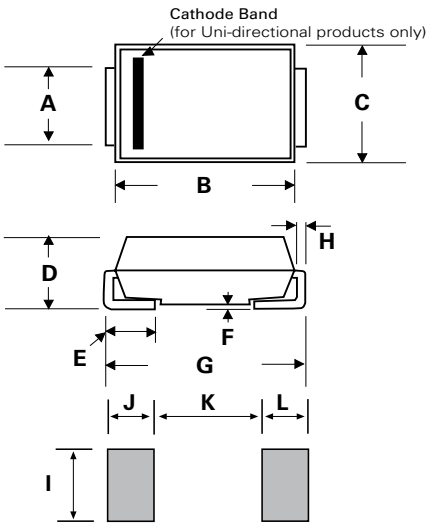
TVS Diodes
Surface Mount – 400W > SMAJ-E Series

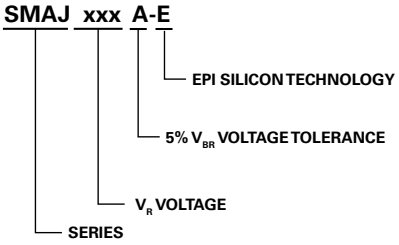
Dimensions

DO-214AC (SMA)

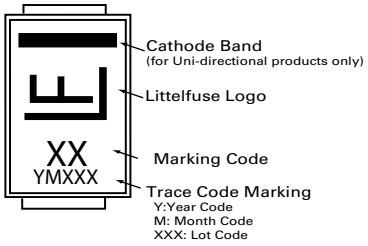


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.049	0.065	1.250	1.650
B	0.157	0.181	3.990	4.600
C	0.095	0.110	2.400	2.790
D	0.075	0.090	1.900	2.290
E	0.030	0.060	0.780	1.520
F	-	0.008	-	0.203
G	0.189	0.208	4.800	5.280
H	0.006	0.012	0.152	0.305
I	0.070	-	1.800	-
J	0.082	-	2.100	-
K	-	0.090	-	2.300
L	0.082	-	2.100	-

Part Numbering System



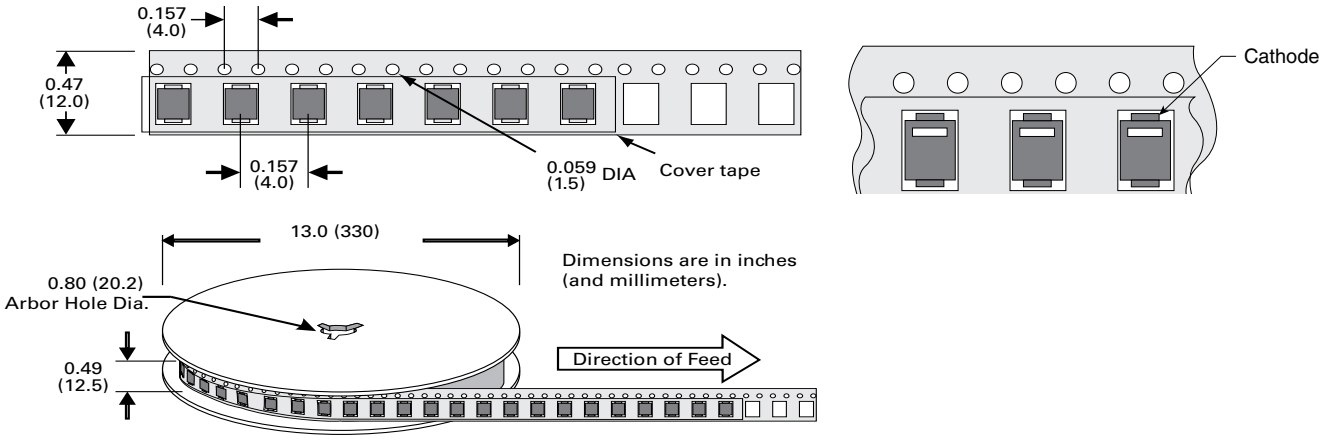
Part Marking System



Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMAJxxxA-E	DO-214AC	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

Tape and Reel Specification



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